

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device integration (FDI) –
Part 150-1: Profiles – ISA100 WIRELESS**

**Intégration des appareils de terrain (FDI) –
Partie 150-1: Profils – ISA100 WIRELESS**





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The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/765/FDIS	65E/775/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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FIELD DEVICE INTEGRATION (FDI) – Part 150-1: Profiles – ISA100 WIRELESS

1 Scope

This part of IEC 62769 specifies an FDI profile for IEC 62734 (ISA100 WIRELESS)¹.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62734:2014, *Industrial networks – Wireless communication network and communication profiles – ISA 100.11a*

IEC 61804 (all parts), *Function blocks (FB) for process control and electronic device description language (EDDL)*

IEC 62541-6, *OPC Unified Architecture – Part 6: Mappings*

IEC 62541-100:2015, *OPC unified architecture – Part 100: Device Interface*

IEC 62769-2, *Field Device Integration (FDI) – Part 2: FDI Client*

IEC 62769-4, *Field Device Integration (FDI) – Part 4: FDI Packages*

IEC 62769-5, *Field Device Integration (FDI) – Part 5: FDI Information Model*

IEC 62769-6, *Field Device Integration (FDI) – Part 6: FDI Technology Mapping*

IEC 62769-7, *Field Device Integration (FDI) – Part 7: FDI Communication Devices*

3 Terms, definitions, abbreviated terms and acronyms

3.1 Terms and definitions

No terms and definitions are listed in this document.

For the purposes of this document, the terms and definitions given in IEC 62734, IEC 61804 (all parts), IEC 62541-100, IEC 62769-4, IEC 62769-5, and IEC 62769-7 and the following apply.

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